PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

EPAS ID: PAT2585388

SUBMISSION TYPE:	CORRECTIVE ASSIGNMENT
NATURE OF CONVEYANCE:	Corrective Assignment to correct the SPELLING OF THIRD INVENTOR'S NAME HEESO LEE previously recorded on Reel 031281 Frame 0302. Assignor (s) hereby confirms the ASSIGNMENT.

CONVEYING PARTY DATA

Name	Execution Date
OH HAN KIM	09/25/2013
SEIL JUNG	09/25/2013
HEESOO LEE	09/25/2013
JAE HAN CHUNG	09/25/2013
YOUNGCHUL KIM	09/25/2013

RECEIVING PARTY DATA

Name:	STATS ChipPAC Ltd.
Street Address:	10 Ang Mo Kio Street 65
Internal Address:	#05-17/20 Techpoint
City:	Singapore
State/Country:	SINGAPORE
Postal Code:	569059

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14037110

CORRESPONDENCE DATA

 Fax Number:
 (408)738-0881

 Phone:
 408-738-0592

Email: efiling@ishimarulaw.com

Correspondence will be sent via US Mail when the email attempt is unsuccessful.

Correspondent Name: ISHIMARU & ASSOCIATES LLP

Address Line 1: 2055 GATEWAY PLACE

Address Line 2: SUITE 700

Address Line 4: SAN JOSE, CALIFORNIA 95110

PATENT

REEL: 031448 FRAME: 0284

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ATTORNEY DOCKET NUMBER:	27-894	
NAME OF SUBMITTER:	MIKIO ISHIMARU	
Signature:	/Mikio Ishimaru/	
Date:	10/21/2013	
	This document serves as an Oath/Declaration (37 CFR 1.63).	
Total Attachments: 11 source=502509601_27-894_Corrective_Assignment_Statement#page1.tif source=502509601_27-894_Corrective_Assignment_Statement#page2.tif source=502509601_27-894_Corrective_Assignment_Statement#page3.tif source=502509601_27-894_Corrective_Assignment_Statement#page4.tif source=502509601_27-894_Corrective_Assignment_Statement#page5.tif source=502509601_27-894_Corrective_Assignment_Statement#page6.tif source=502509601_27-894_Corrective_Assignment_Statement#page7.tif source=502509601_27-894_Corrective_Assignment_Statement#page8.tif source=502509601_27-894_Corrective_Assignment_Statement#page9.tif source=502509601_27-894_Corrective_Assignment_Statement#page9.tif source=502509601_27-894_Corrective_Assignment_Statement#page9.tif		

PATENT REEL: 031448 FRAME: 0285

PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date	
Oh Han Kim	09/25/2013	
Sell Jung	09/25/2013	
HeeSo Lee	09/25/2013	
Jae Han Chung	09/25/2013	
YoungChul Kim	09/25/2013	

RECEIVING PARTY DATA

Name:	STATS ChipPAC Ltd.	
Street Address:	10 Ang Mo Kio Street 65	
Internal Address:	#05-17/20 Techpoint	
City:	Singapore	
State/Country:	SINGAPORE	
Postal Code:	569059	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14037110

CORRESPONDENCE DATA

4087380881 Fax Number:

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Phone: 408-738-0592

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ISHIMARU & ASSOCIATES LLP Correspondent Name:

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Address Line 2: Suite 700

Address Line 4: San Jose, CALIFORNIA 95110

ATTORNEY DOCKET NUMBER:	27-894
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REEL: 031448 FRAME: 0286

PATENT

Docket No.: 27-894

ASSIGNMENT STATEMENT

Oath/Declaration Statement Included

WHEREAS, the undersigned (hereinafter termed Assignor(s)) has/have invented certain new and useful improvements in

INTEGRATED CIRCUIT PACKAGING SYSTEM WITH HEAT SPREADER AND METHOD OF MANUFACTURE THEREOF

for which a United States patent application has been executed on or before the date of this assignment.

WHEREAS, STATS ChipPAC Ltd., a Corporation of Singapore, having a place of business at 10 Ang Mo Kio Street 65, #05-17/20 Techpoint, Singapore 569059, Republic of Singapore (hereinafter termed Assignee), is desirous of acquiring the entire right, title and interest in and to said application and said invention and improvements thereon, and in and to Letters Patents thereon when granted in the United States and foreign countries.

NOW, THEREFORE, for good and valuable consideration received by said Assignor(s) from said Assignee(s), the receipt of which is hereby acknowledged by said Assignor(s):

- 1. Said Assignor(s) hereby state that I/we have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.
- 2. Said Assignor(s) does not know/do not know and does not believe/do not believe the same was ever known or used in the United States of America before this invention thereof or more than one year prior to this application, and that the same was not in public use or on sale in the United States of America more than one year prior to this application. I acknowledge the duty to disclose information which is known to me to be material to patentability in accordance with title 37, Code of Federal Regulations, section 1.56.
- 3. Said Assignor(s) does hereby sell, assign, transfer and convey unto said Assignee(s), the entire right, title and interest in and to said application and said invention and in and to any and all improvements on said invention and in and to any and all improvements on said invention heretofore or hereafter made or acquired by said Assignor(s); and in and to any and all Letters Patent on said invention and/or said improvements that may be granted in the United States or any foreign country, including each and every Letters Patent granted on any application which is a division, continuation, substitution, renewal, or continuation-in-part of any said application, and in and to each and every reissue or extension of said Letters Patent.
- Assignee(s) may enjoy to the fullest extent the right, title and interest herein conveyed. Such cooperation shall include (a) prompt execution of all papers (prepared at the expense of Assignee(s)) which are deemed necessary or desirable by Assignee(s) to perfect in it the right, title and interest herein conveyed, (b) prompt execution of all petitions, oaths, specifications or other papers (prepared at the expense of Assignee(s)) which are deemed necessary or desirable by Assignee(s) for prosecuting said application, for filing and prosecuting divisional, continuation, substitution, renewal, continuation-in-part, or additional applications in the United States and/or foreign countries covering said invention and/or said improvements, for filing and prosecuting applications for reissuance of letters patent included herein, or for interference proceedings involving said invention and/or said improvements and (c) prompt assistance and cooperation in the prosecution of interference proceedings involving said invention and/or said improvements and in the adjudication of said Letters Patent, particularly by the disclosure of facts and the production of evidence relating to said invention

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and/or said improvements, provided the expenses which may be incurred by said Assignor(s) in lending such assistance and cooperation shall be paid by the Assignee(s).

- 5. The terms, covenants and conditions of this assignment shall inure to the benefit of said Assignee(s), its successors, assigns and/or other legal representatives and shall be binding upon said Assignor(s), his/her heirs, legal representatives and assigns.
- 6. Said Assignor(s) hereby warrants and represents that he/she has not entered into any assignment, contract or understanding in conflict herewith.

Authorization to Permit Access To Application by Participating Office

If checked, the undersigned hereby grants the USPTO authority to provide the European Patent Office (EPO), the Japan Patent Office (JPO), the Korean Intellectual Property Office (KIPO), the World Intellectual Property Office (WIPO), and any other intellectual property offices in which a foreign application claiming priority to the above-identified patent application is filed access to the above-identified patent application. See 37 CFR 1.14(c) and (h). This box should not be checked if the applicant does not wish the EPO, JPO, KIPO, WIPO, or other intellectual property office in which a foreign application claiming priority to the above-identified patent application is filed to have access to the above-identified patent application.

In accordance with 37 CFR 1.14(h)(3), access will be provided to a copy of the above-identified patent application with respect to: 1) the above-identified patent application —as-filed; 2) any foreign application to which the above-identified patent application claims priority under 35 U.S.C. 119(a)-(d) if a copy of the foreign application that satisfies the certified copy requirement of 37 CFR 1.55 has been filed in the above-identified patent application; and 3) any U.S. application-as-filed form which benefit is sought in the above-identified patent application.

In accordance with 37 CFR 1.14(c), access may be provided to information concerning the date of filing the Authorization to Permit Access to Application by Participating Offices.

7. Said Assignor(s) hereby claim foreign priority benefits under Title 35, United States Code, Section 119(a)-(d) or Section 365(b) of any foreign application(s) for patent or inventor's certificate, or Section 365(a) of any PCT international application which designated at least one country other than the United States listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s):

			Priority	Claimed
Number	Country	Day/Month/Year filed	<u>Yes</u>	<u>No</u>

8. Said Assignor(s) hereby claim the benefit under 35 USC 119(e) of any United States provisional application(s) listed below:

Prior Provisional Application(s):

Serial No.	Filing Date

9. Said Assignor(s) hereby claim the benefit under Title 35, United States Code, Section 120 of any United States application(s), or Section 365(c) of any PCT international application designating

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the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT international application in the manner provided by the first paragraph of Title 35, United States Code, Section 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, Section 1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

Prior U.S. Application(s):

Serial No.	Filing Date

10. Said Assignor(s) hereby authorizes and requests the attorney(s) of record in this application to insert the serial number and filing date of this Non Provisional application in the spaces that follow:

Serial No.	Filing Date
14/037,110	September 25, 2013

ASSIGNMENT STATEMENT

Docket No.: 27-894

The above-identified application was made or authorized to be made by the Assignor(s), who believe(s) that I am/we are the original inventor(s) or an original joint inventor(s) of a claimed invention in the application.

Said Assignor(s) hereby acknowledge that any willful false statement made in this Assignment is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both. Said Assignor has executed and delivered this instrument on the date set forth below.

Inventor's signature:

Date: 10/3. 38

Full name of inventor:

Oh Han Kim

Citizenship:

Republic of Korea

Residence Address:

105-202 Hyundai I-Park Apt

Sadong-ri, Daewol-myeon Icheon-si, Kyonggi-do

Korea

Post Office Address:

5 Yishun Street 23

Singapore 768442

The above-identified application was made or authorized to be made by the Assignor(s), who believe(s) that I am/we are the original inventor(s) or an original joint inventor(s) of a claimed invention in the application.

Said Assignor(s) hereby acknowledge that any willful false statement made in this Assignment is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both. Said Assignor has executed and delivered this instrument on the date set forth below.

Inventor's signature:

Date: 25 Sep 2013

Full name of inventor:

Sell Jung

Citizenship:

Republic of Korea

Residence Address:

103-201, Raemian Pentaville APT

Yeoksam-ong, Gangnam-gu

Seoul, Korea

Post Office Address:

5 Yishun Street 23

Singapore 768442

ASSIGNMENT STATEMENT

Date: <u>Gep</u> 25/13

Docket No.: 27-894

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Said Assignor(s) hereby acknowledge that any willful false statement made in this Assignment is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both. Said Assignor has executed and delivered this instrument on the date set forth below.

Inventor's signature:

+--

Full name of inventor:

HeeSoo Lee

Citizenship:

Republic of Korea

Residence Address:

1490-11 #1, Kwanyang-dong,

Anyang-si

Kyunggi-do,

<u>Korea</u>

Post Office Address:

5 Yishun Street 23

Singapore 768442

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Inventor's signature:

Date: Sep. 25 1/3

Full name of inventor:

Jae Han Chung

Citizenship:

Republic of Korea

Residence Address:

209-1803, Samsung Raemian 2 APT

Giheung-gu

Yongin-si, Kyunggi-do

Korea

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5 Yishun Street 23

Singapore 768442

Docket No.: 27-894

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Said Assignor(s) hereby acknowledge that any willful false statement made in this Assignment is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both. Said Assignor has executed and delivered this instrument on the date set forth below.

Inventor's signature: ______
Full name of inventor:

YoungChul Kim

Citizenship:

Republic of Korea

Residence Address:

209-601, Suii-Xi 2 APT

Sungbok-dong

Youngin-si, Kyunggi-do

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